Standardized Info	ormation for Process/Product Cha	ange Notification (I	PCN)			1. PCN basic data				
			Name Customer:			1. PCN basic data				
Customer			Contact Email addres	is:						
customer					1	I				
	1.11		Site submitting the o	change:				Melexis leper		
	Melexis					1				
	INSPIRED ENGINEERING		Affected site(s):		Melexis Supplier	Melexis leper	Melexis Erfurt	Melexis Sofia		
1.1 Company 1.2 PCN No. 1.3 Title of PCN 1.4 Product Cate			MCM-5707							
1.3 Title of PCN 1.4 Product Cate	PROTV		Michier 2011 Business Continuity Plan Unisem Batam Products Active Components - Integrated Circuits							
1.5 Issue date 1.6 PCN revision	history (antional)		Rever Components - Integrated Circuits 16-07-19 1.7 Issue date of previous revision 1.8 Delta to previous revision (optional)							
V1.0 V2.0	i history (optional)		1.7 issue date of pre-	15-07-19	Initial PCN Initial PCN upda					
V2.0 V3.0				29-08-19 18-06-20	final PCN updat	te ucts in UA GR				
						2. PCN Team				
2.1 Contact supp	blier		pcn mlx (Lisa Vanhe			Life in reality				
2.1.2 Phone			+32 57 22 62 07							
2.1.3 Email 2.2 Team supplie	er (optional)		pcn_mlx@melexis.co	m						
2.2.1 Name (opt Hanne Thielens)	ional) Customer Communication Coordi	nation	2.2.2 Phone (optiona	al)		2.2.3 Email (optional) hth@melexis.com				
Vincent Vanzeve Karen Stinckenst	er (optional) ional) Justomer Communication Coordii renGlobal Quality Manager Global Purchasing Manager					vvn@melexis.com kss@melexis.com				
Tim VangervenP	Global Purchasing Manager ackage Architect Inctional Safety and Reliability Ma					tmv@melexis.com ade@melexis.com				
Arriado Devosi o	inclorial callety and reliability ma	liagei								
No.	3.0 Ident		3.1 Category			3. Changes 3.2 Type of change				
No. #1 #2	SEM-PA-18 SEM-PA-02		PROCESS - ASSEMBLY PROCESS - ASSEMBLY			Move of all or part of assembly Change of leadframe base mat		a/subcontractor		
#3	SEM-PA-07		PROCESS - ASSEM	BLY		Die attach material				
#4 #5	SEM-PA-16 SEM-PA-17		PROCESS - ASSEM			Change of direct material supp Change of specified-assembly		ion and/or additional proc	ess step)	
#6	SEM-PA-19 SEM-EQ-02		PROCESS - ASSEMI EQUIPMENT			Die Scribe or separation			placement equipment or extension of existing equipment pool	
.,			Capor WENT			without change of process.	convictor which uses the S	and pape technology (re	provinces equipment or extension or existing equipment pool	
	•					•				
		Old			4. De	escription of change New				
Change #1		Assembly house C151	location : Unisem Bata	m (Indonesia)		Assembly house location : See EFTEC-3S	e section 11.			
Change #2 Change #3		CRM1076WA				CRM1033BF				
Change #4		leadframe suppl gold wire supplie	ier: HDS er: Heraeus			leadframe supplier: ECE gold wire supplier: Tanaka				
Change #5		Process sequen	ce Unisem :			Process sequence Lingsen :	aulation			
Change #6		Plating -> Dejun die sawing meth	k / Trim / Singulation od: Single			Dejunk / Trim -> Plating -> Sin die sawing method: Dual	guiduuri			
Change #7						sawing, plasma cleaning, mold	ling			
4.6 Anticipated i reliability or pro	impact on form, fit, function,	 Based on Risk Use of package 	Assessment including generic qualification d	AEC-Q100 and ZV ata (from the asser	El guidelines mbly houses and N	Melexis) considering Automotive	Grades, Assembly Bill-of	-Material & Bill-of-Proces	s and Wafer Technology	
		- Whenever pos	sible, re-use of Melexis	qualified Bill-of-Ma	terial & Bill-of-Pro	cess will be applied				
6.1 Description			Traceability through le	ot number and ship		parts / traceability of change				
7.1 Date of quali	ification results		available		/.	Timing / schedule				
7.2 Last order da 7.3 Last delivery	r date (optional)		Closed Q4 2019							
7.4 Intended sta			Q2 2020 Yes available							
	n samples available? edback required until		30-Jun-2020							
710 customer re	cubick required until		30-5011-2020		!					
8.1 Description ((e.g. qual. plan/report, AEC-Q)	1	- Based on Risk Asse	ssment including A	AEC-Q100 and ZV	alification / validation /El guidelines				
			- Use of package gen	eric qualification da	ata (from the asser	mbly houses and Melexis) consid aterial & Bill-of-Process will be ap	dering Automotive Grade plied	s, Assembly Bill-of-Materi	al & Bill-of-Process and Wafer Technology	
8 2 Qualificati	report and qualification and it									
8.2 Qualification report and qualification results					issue date					
See attached pre	sentation: BOM & BOP Risk Asse	ssment			9. Input to custo	omer for risk assessment proces	S			
			10 Attac	ments (e.g. now	datasheet. additio	onal documentation, pictures, p	process flow, sample pla	n)		
			-0. Add	1	ee, uuun		en, enpie pla			
	Assessment UA without Cap_Fin luct_Qualification_Report.pdf	al_Lingsen.pdf								
	luct_Qualification_Report.pdf luct_Qualification_Report.pdf									
ridu	eportpul									
					1	1. Affected parts				
11.1 Current				11.1.5	11.1.6	11.2 New (if applicable)	1	I	luna -	
11.1.1 Customer Part		11.1.3 Assembly	11.1.4 Package	Part Description	Additional Part Information		11.2.3		11.2.6 Additional Part	
No.	11.1.2 Supplier Part Name	House	Name	(optional)	(optional)	11.2.2 Supplier Part Name	Assembly House	11.2.4 Package Name	Information (optional)	
N/A N/A	MLX92211LUA-AAA-000-BU MLX92241LUA-AAA-003-BU	Unisem Batam Unisem Batam	UA GR UA GR			MLX92211LUA-AAA-000-BU MLX92241LUA-AAA-003-BU	Lingsen, Taiwan	UAGR		
N/A N/A	MLX92241LUA-AAA-005-BU MLX92241LUA-AAA-007-BU	Unisem Batam Unisem Batam	UA GR UA GR			MLX92241LUA-AAA-005-BU MLX92241LUA-AAA-007-BU	Lingsen, Taiwan	UA GR UA GR		
N/A	MLX92242LUA-AAA-000-BU	Unisem Batam	UA GR			MLX92242LUA-AAA-000-BU	Lingsen, Taiwan	UAGR		
		1	1	1	1	1	1	1	- was for intermediate solution only	
N/A	MLX92211LUA AAA 000 BU	Unisem Batam	UA GR	1		MLX92211LUA AAL 000 BU	Lingsen, Taiwan	UA GR	- the PCN does not cover and support the intermediate solution anymore	
		+							- the intermediate solution go to End of Life until Q1/2021 - was for intermediate solution only	
N/A	MLX92241LUA AAA 003 BU	Unisem Batam	UA GR	1		MLX92241LUA AAL 003 BU	Lingsen, Taiwan	UA GR	- the PCN does not cover and support the intermediate solution	
·									anymore - the intermediate solution go to End of Life until Q1/2021	
									- was for intermediate solution only - the PCN does not cover and support the intermediate solution	
N/A	MLX92241LUA AAA 005 BU	Unisem Batam	UA GR	1		MLX92241LUA AAL 005 BU	Lingsen, Taiwan	UAGR	anymore - the intermediate solution go to End of Life until Q1/2021	
	l	1	1	1		t		İ	- was for intermediate solution only	
N/A	MLX92241LUA-AAA-007-BU	Unisem Batam	UA GR			MLX92241LUA-AAL-007-BU	Lingsen, Taiwan	UAGR	- the PCN does not cover and support the intermediate solution anymore	
		+			<u> </u>	<u> </u>			the intermediate solution go to End of Life until Q1/2021 was for intermediate solution only	
N/A	MLX92242LUA AAA 000 BU	Unisem Batam	UA GR			MLX92242LUA AAL 000 BU	Lingsen, Taiwan	UA GR	- the PCN does not cover and support the intermediate solution anymore	
							L		- the intermediate solution go to End of Life until Q1/2021	

	Title of PCN:			
Business Continuity Plan Unisem Batam Products				
Customer PCN No.	Supplier PCN No.	MCM-5707		

1. Feedback	date:	
We agree with this proposed change for the parts as listed in chapter '11. Affected parts'. Approval letter will be sent in written form.		
We agree with this proposed change schedule and will start with the PCN process. Approval letter will be sent in written form after evaluation.		
We disapprove because:		
Remark:		

2. Feedback	date:			
We acknowledge qualification / validation as assigned in chapter 8 of the PCN.				
We need more information:				
We need the following samples:				
Estimated closing date for PCN:				

Final Feedback/Approval	date:	

Sender:		
Company:		
Name:		
Address/Location:		
Signature:		
Date:		

Please return to: [your Sales partner]			
Name:	pcn_mlx (Lisa Vanheerswynghels)		
Address/Location:			
	+32 57 22 62 07		
Fax:			
Email:	pcn_mlx@melexis.com		